



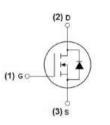
MJ N-Channel Enhancement Mode Power MOSFET

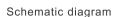
Description

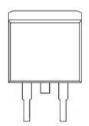
The MJ80H16D uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- $V_{DS} = 80V, I_{D} = 160A$ R_{DS(ON)} < 4.7mΩ @ V_{GS}=10V
- ◆ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high Eas
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability







Application

Automotive applications

Uninterruptible power supply

Hard switched and high frequency circuits

Marking and pin assignment



TO-263-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ80H16D	MJ80H16D	TO-263-2L	2	-	-

Absolute Maximum Ratings (Tc=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	80	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	160	Α
Drain Current-Continuous(Tc =100°C)	I _D (100℃)	113	А
Pulsed Drain Current	Ідм	500	Α
Maximum Power Dissipation	Po	285	W
Derating factor		1.9	W/°C
Single pulse avalanche energy (Note 5)	Eas	1936	mJ
Operating Junction and Storage Temperature Range	Тл ,Тѕтс	-55 To 175	°C

Thermal Characteristic

Thermal Resistance,Junction-to-Case (Note 2)	0.53 °C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	·						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250μA	80	88	-	V	
Zero Gate Voltage Drain Current	oltage Drain Current I _{DSS} V _{DS} =80V,V _{GS} =0V - 1		μA				
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V _G S(th)	V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V	
Drain-Source On-State Resistance	RDS(ON)	V _{GS} =10V, I _D =20A	-	3.7	4.7	mΩ	
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A	60	-	-	S	
Dynamic Characteristics (Note 4)	-						
Input Capacitance	Clss		-	6500	-	PF	
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V F=1.0MHz	-	810	-	PF	
Reverse Transfer Capacitance	Crss		-	310	-		
Switching Characteristics (Note 4)	-						
Turn-on Delay Time	t _{d(on)}		-	31.5	-	nS	
Turn-on Rise Time	tr	V _{DD} =40V,I _D =2A,R _L =15Ω	-	33	-	nS	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =10V,R _G =2.5Ω	-	46	-	nS	
Turn-Off Fall Time	tr				nS		
Total Gate Charge	Qg		-	130			
Gate-Source Charge	Qgs	V _{DS} =40V,I _D =20A V _{GS} =10V	-	36	-	nC	
Gate-Drain Charge	Qgd	-	-	46	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	Vsp	V _{GS} =0V,I _S =40A	-	-	1.2	V	
Diode Forward Current (Note 2)	vard Current (Note 2) Is 160		А				
Reverse Recovery Time	trr	TJ=25°C, IF=20A	-	51	-	nS	
Reverse Recovery Charge	Qrr	di/dt= 500A/µs (Note 3)	-	61	- nS - nC		
Forward Turn-On Time	ton	Intrinsic turn-on time is ne	aligible(ti	ırn-on is d	ominated h	nC	

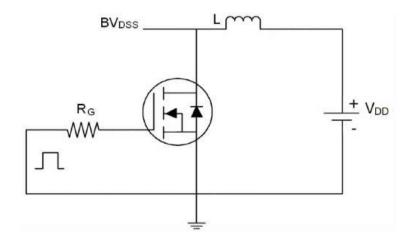
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, $t \le 10$ sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- § EAS condition: Tj=25°C,VDD=40V,VG=10V,L=0.5mH,Rg=25 Ω

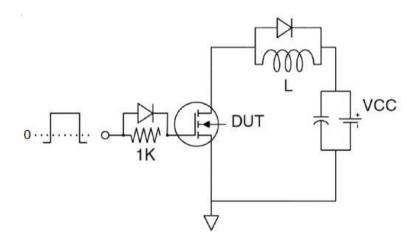




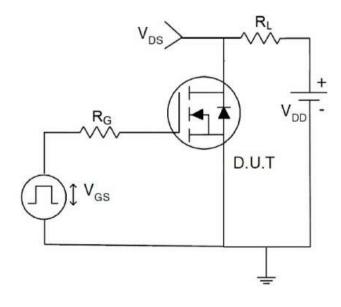
Test circuit



Eas test Circuit



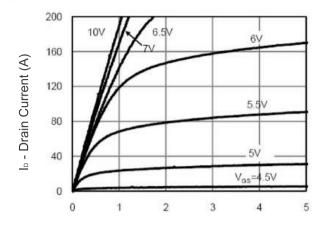
Gate charge test Circuit

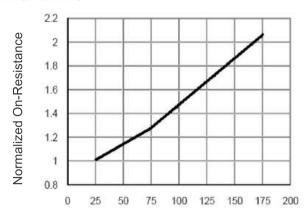


Switch Time Test Circuit



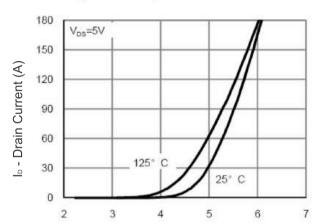
Typical Electrical and Thermal Characteristics (Curves)



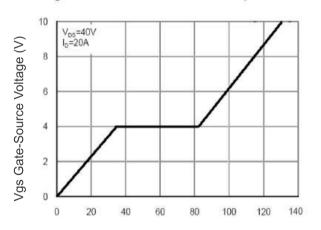


Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



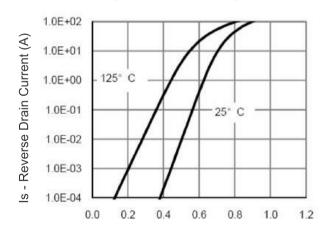
T_J -Junction Temperature(°C) Figure 4 Rdson-Junction Temperature



Vgs Gate-Source Voltage (V) Figure 2 Transfer Characteristics

7 Rdson On-Resistance(mΩ) 6 5 4 V_{GS}=10V 3 2 0 5 10 15 20 25 30

Qg Gate Charge (nC) Figure 5 Gate Charge



I_D - Drain Current (A)

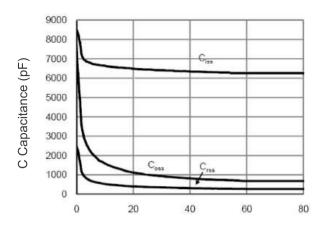
Figure 3 Rdson- Drain Current

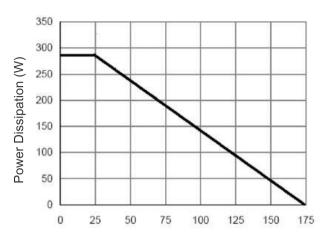
Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward



lo - Drain Current (A)



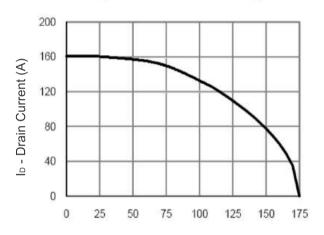




Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds

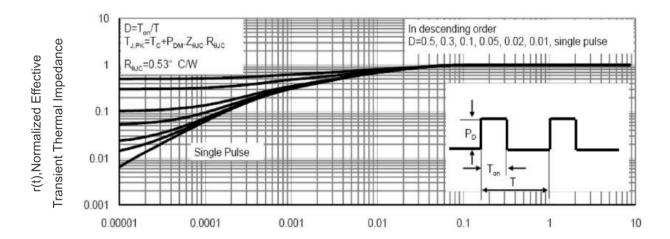
1000.0 R_{DS(ON)} limited 100.0 100µs 10.0 10ms DC 1.0 T_{J(Max)}=175° T_c=25° C 0.1 0.0 0.01 0.1 10 100 1000

T_J -Junction Temperature(°C)
Figure 9 Power De-rating



Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area

T_J -Junction Temperature(°C) Figure 10 Current De-rating



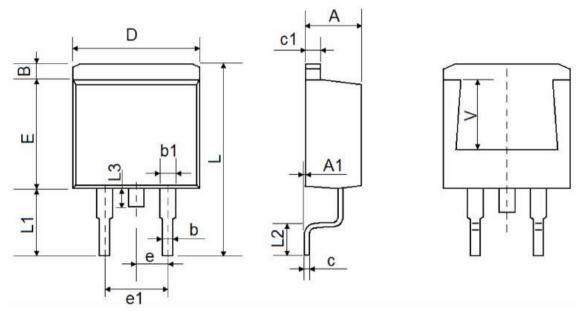
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-263-2L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
c	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
Е	8,500	8.900	0.335	0.350	
е	2.540 TYP.		0.100	TYP.	
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
٧	5.600 REF		0.220	REF	





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